

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	Customer Number: 89518
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LIN, Mou-Shiung, et al.	:	Confirmation Number: 6093
	:	
Application No.: 10/055,568	:	Group Art Unit: 2813
	:	
Filed: January 22, 2002	:	Examiner: MITCHELL, James M.
	:	
For: CHIP PACKAGE WITH DIE AND SUBSTRATE	:	

RESPONSE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the non-final Office Action dated May 13, 2011, the due date for which falling on Monday, August 15, 2011, please amend the above-identified application and consider the remarks as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.

An **Appendix** is attached hereto with the status of the related applications.